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(12) **United States Design Patent** (10) **Patent No.:** **US D819,627 S**
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(54) **THERMOELECTRIC SMARTWATCH**

(71) Applicant: **Matrix Industries, Inc.**, Menlo Park, CA (US)

(72) Inventors: **Akram I. Boukai**, Menlo Park, CA (US); **Douglas W. Tham**, Menlo Park, CA (US); **Haifan Liang**, Menlo Park, CA (US); **Eric C. Hale**, Greenbrae, CA (US); **Gregory L. Kress**, San Francisco, CA (US); **Scott A. Steber**, San Francisco, CA (US); **Brentley M. Wiles**, San Francisco, CA (US); **Michael Chiasson**, San Francisco, CA (US)

(73) Assignee: **MATRIX INDUSTRIES, INC.**, Menlo Park, CA (US)

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CPC .. A41D 1/002; G06F 1/04; G06F 1/08; G06F 1/10; G06F 1/14; G06F 1/1626; G06F 1/1628; G06F 1/163; G06F 1/1635; G06F 1/3203; G06Q 20/10; G06Q 20/12; G06Q 20/108; G06Q 20/145; H04B 1/3833; H04B 1/385; H04B 1/3888; H04M 1/02; H04M 1/03; H04M 1/04; H04M 1/05; H04M 1/667; H04M 1/6058; Y02B 60/1217

See application file for complete search history.

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Primary Examiner — Barbara Fox

Assistant Examiner — Kristin E Reed

(74) *Attorney, Agent, or Firm* — Wilson Sonsini Goodrich & Rosati

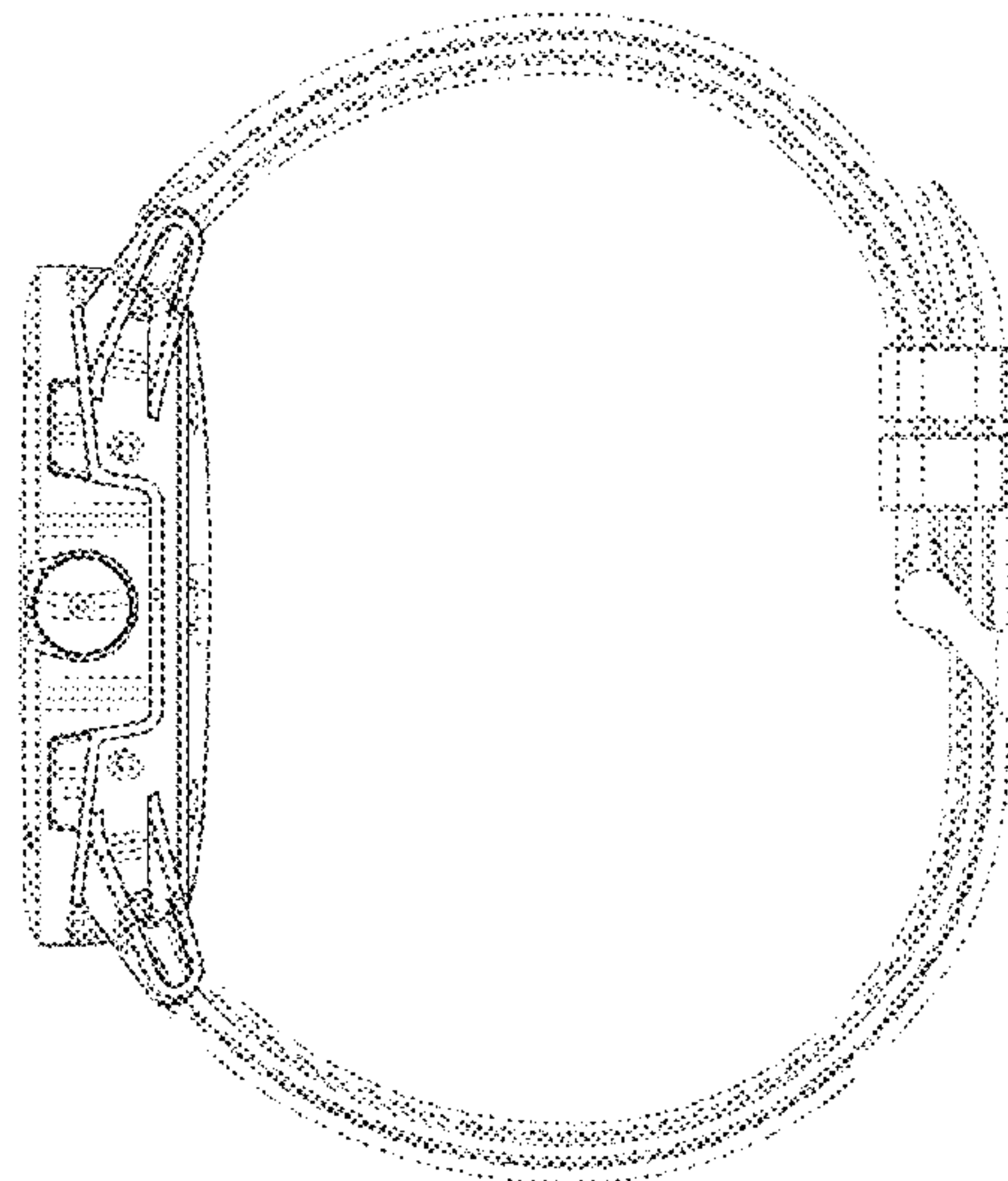
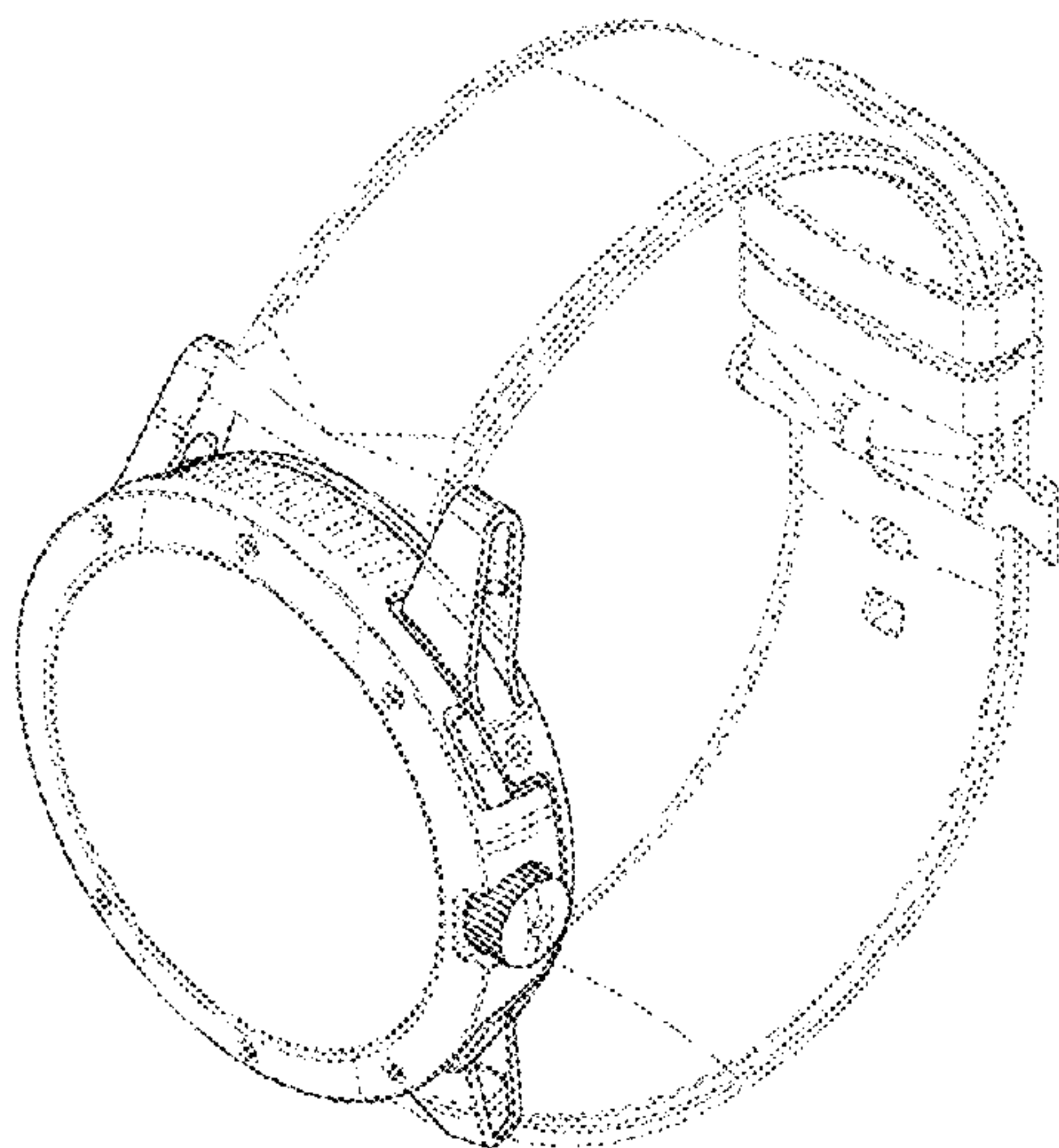
(57) **CLAIM**

The ornamental design for a thermoelectric smartwatch, as shown and described.

DESCRIPTION

FIG. 1 is a top perspective view of a thermoelectric smartwatch in accordance with the present design; FIG. 2 is a front view of the thermoelectric smartwatch; FIG. 3 is a back view of the thermoelectric smartwatch; FIG. 4 is a right side view of the thermoelectric smartwatch; FIG. 5 is a left side view of the thermoelectric smartwatch; FIG. 6 is a top view of the thermoelectric smartwatch; and, FIG. 7 is a bottom view of the thermoelectric smartwatch. The broken lines shown in FIGS. 1-7 in the drawings depict portions of the thermoelectric smartwatch that form no part of the claimed design.

1 Claim, 7 Drawing Sheets



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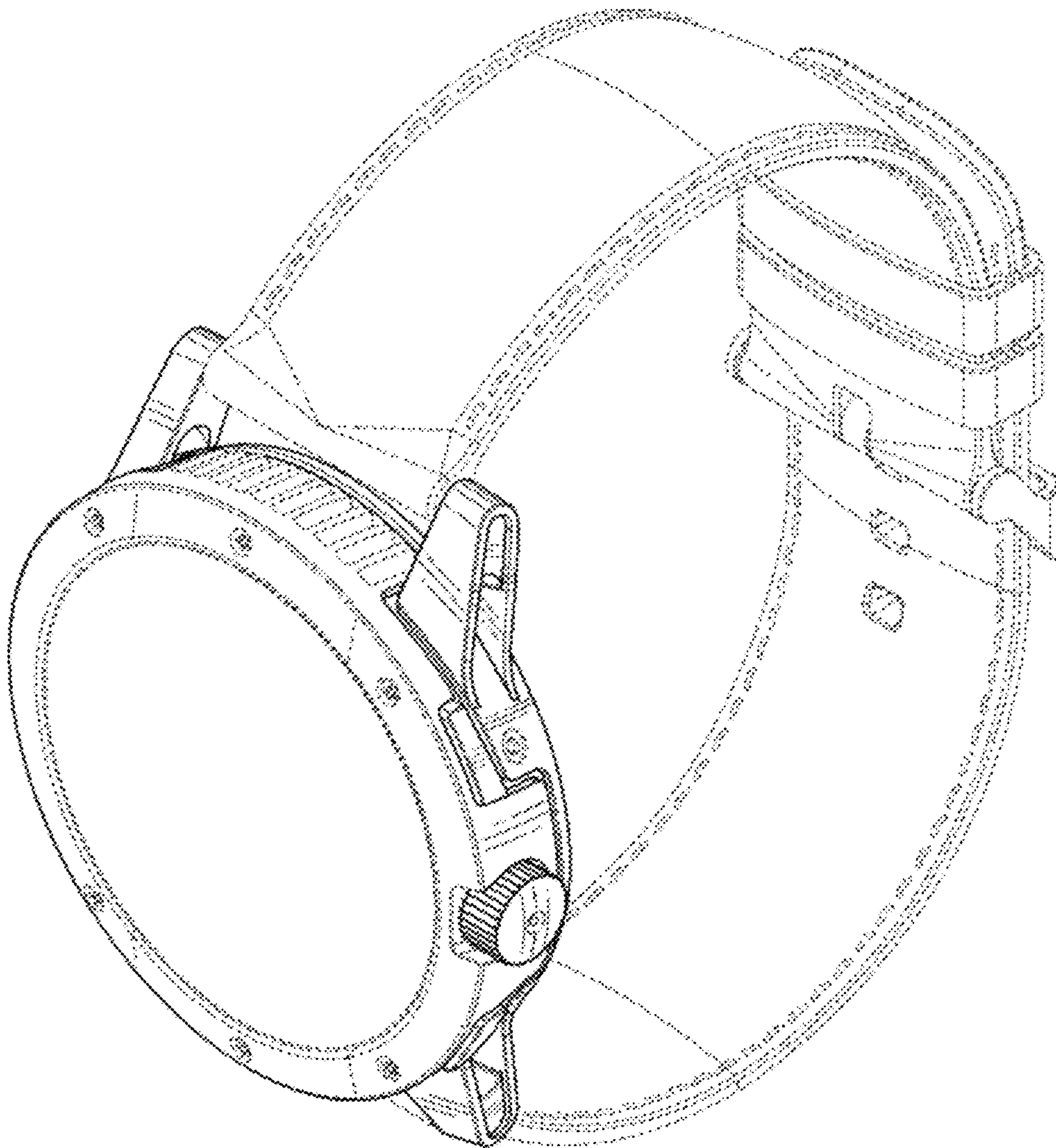


FIG. 1

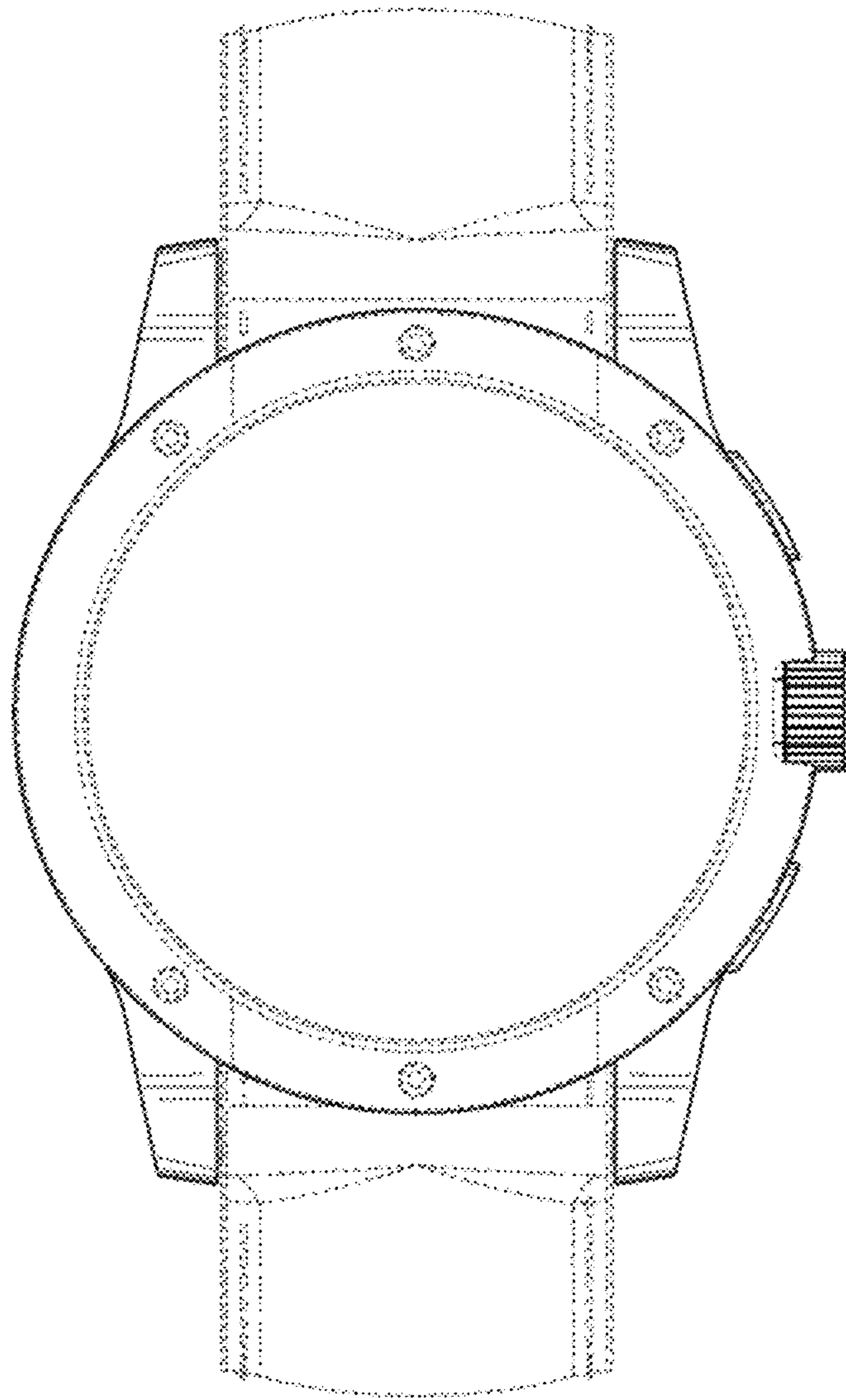


FIG. 2

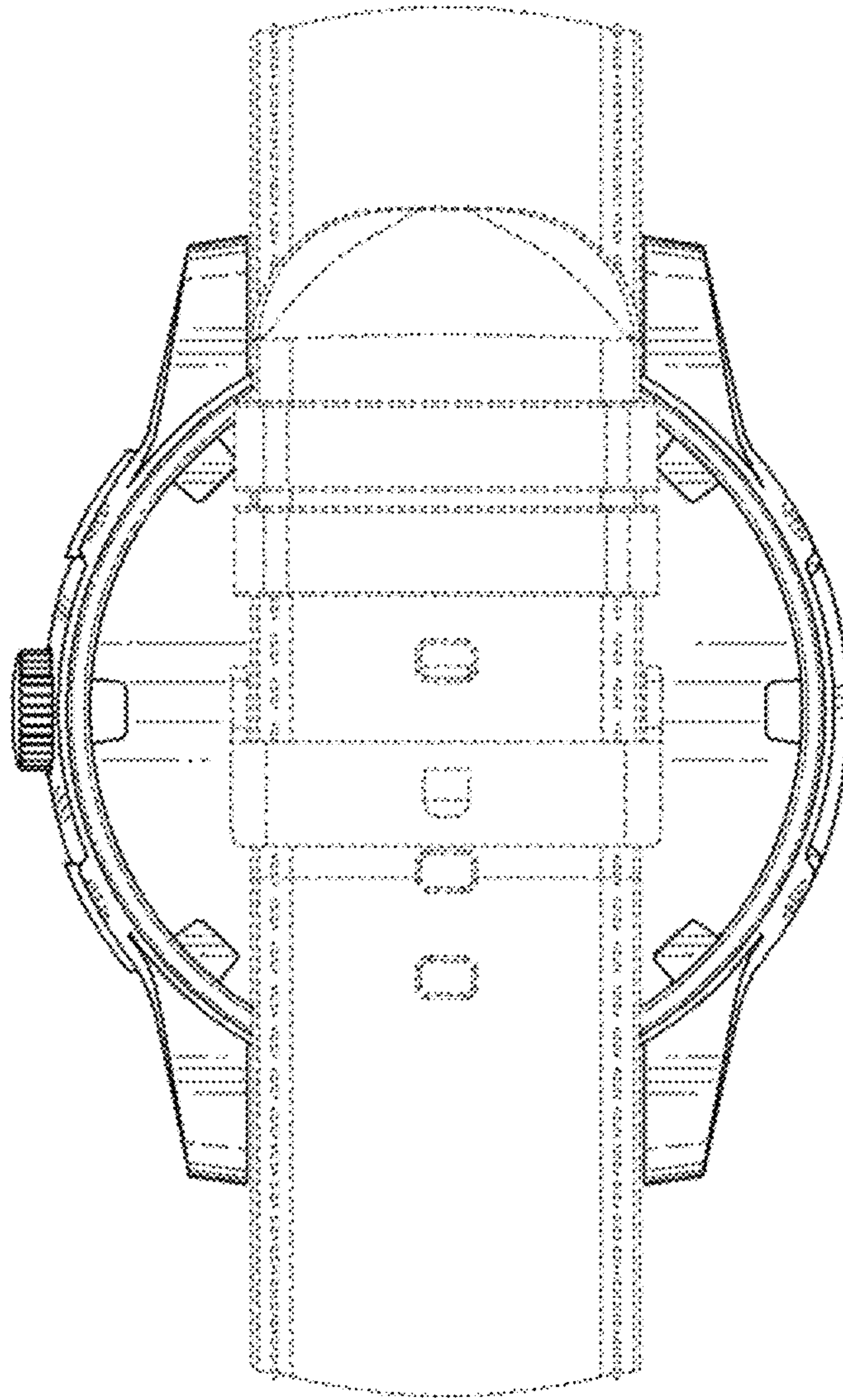


FIG. 3

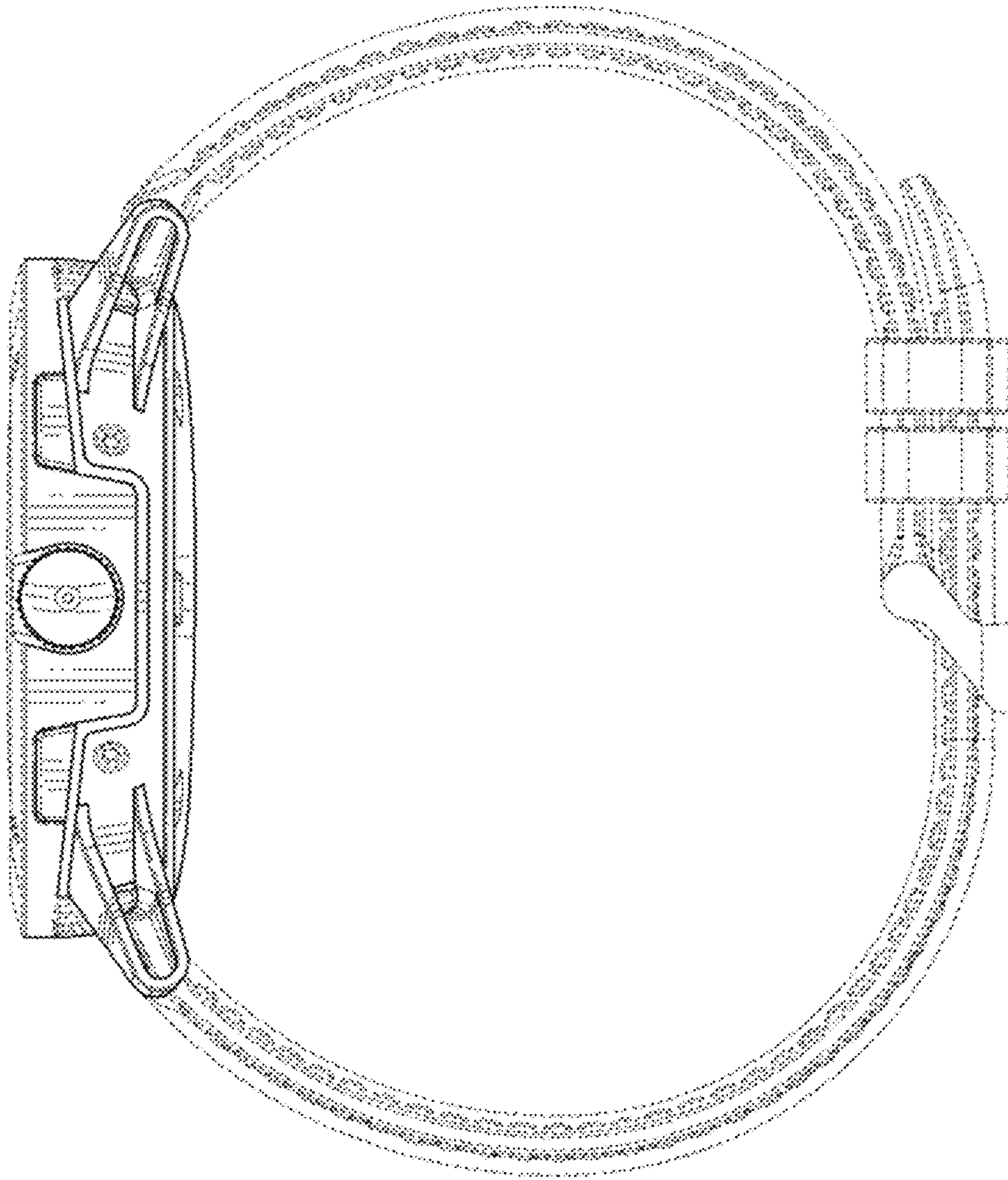


FIG. 4

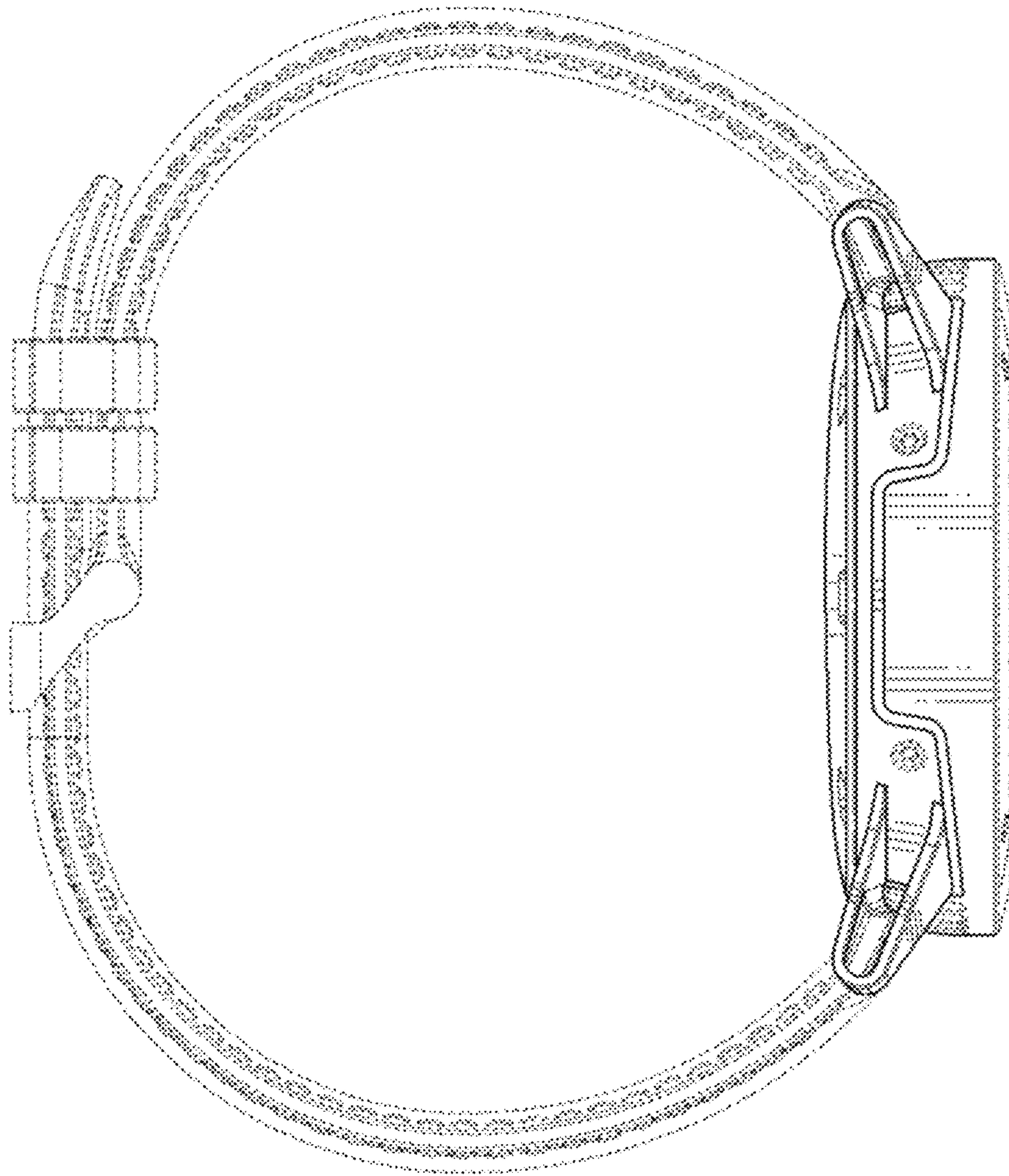


FIG. 5

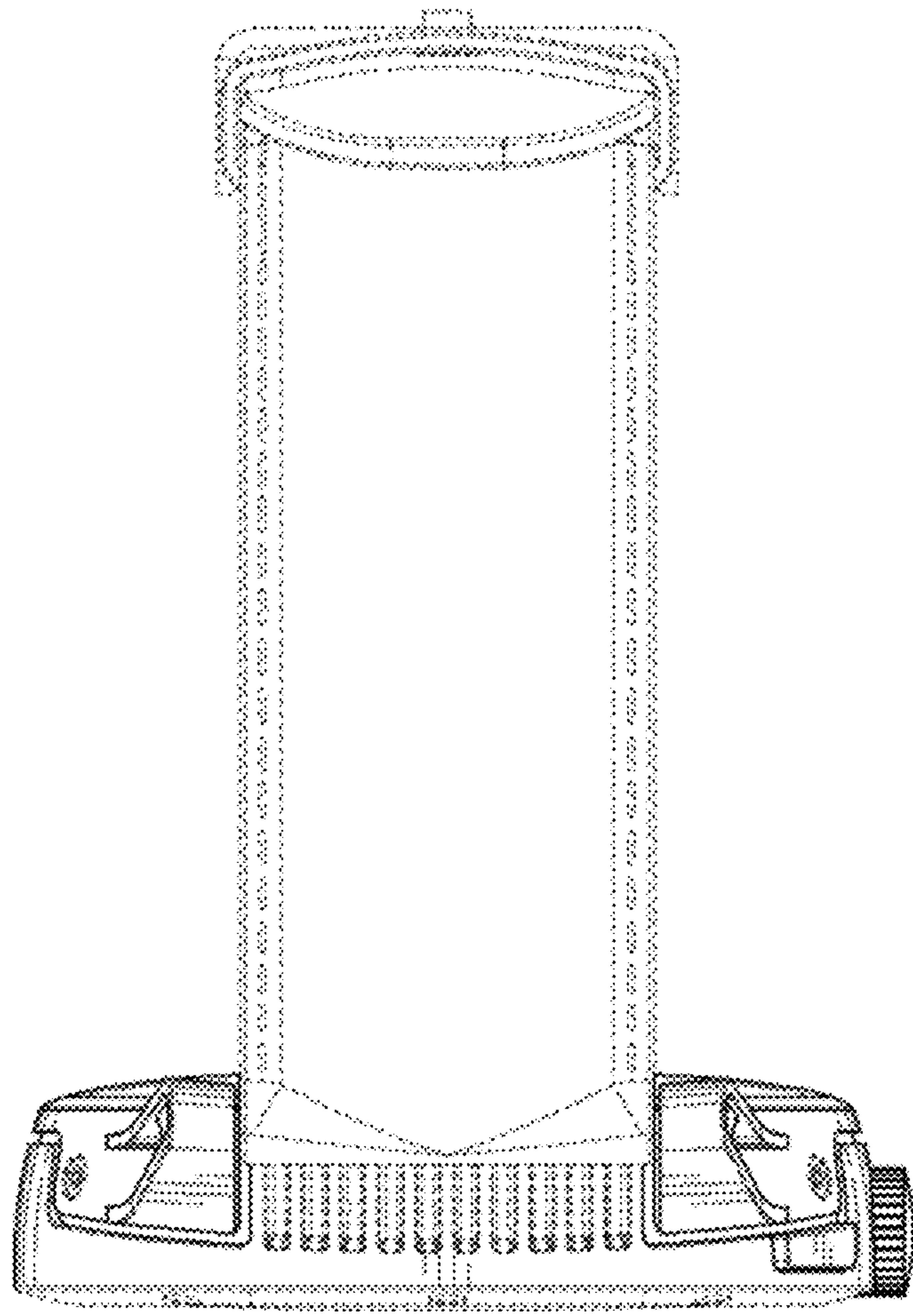


FIG. 6

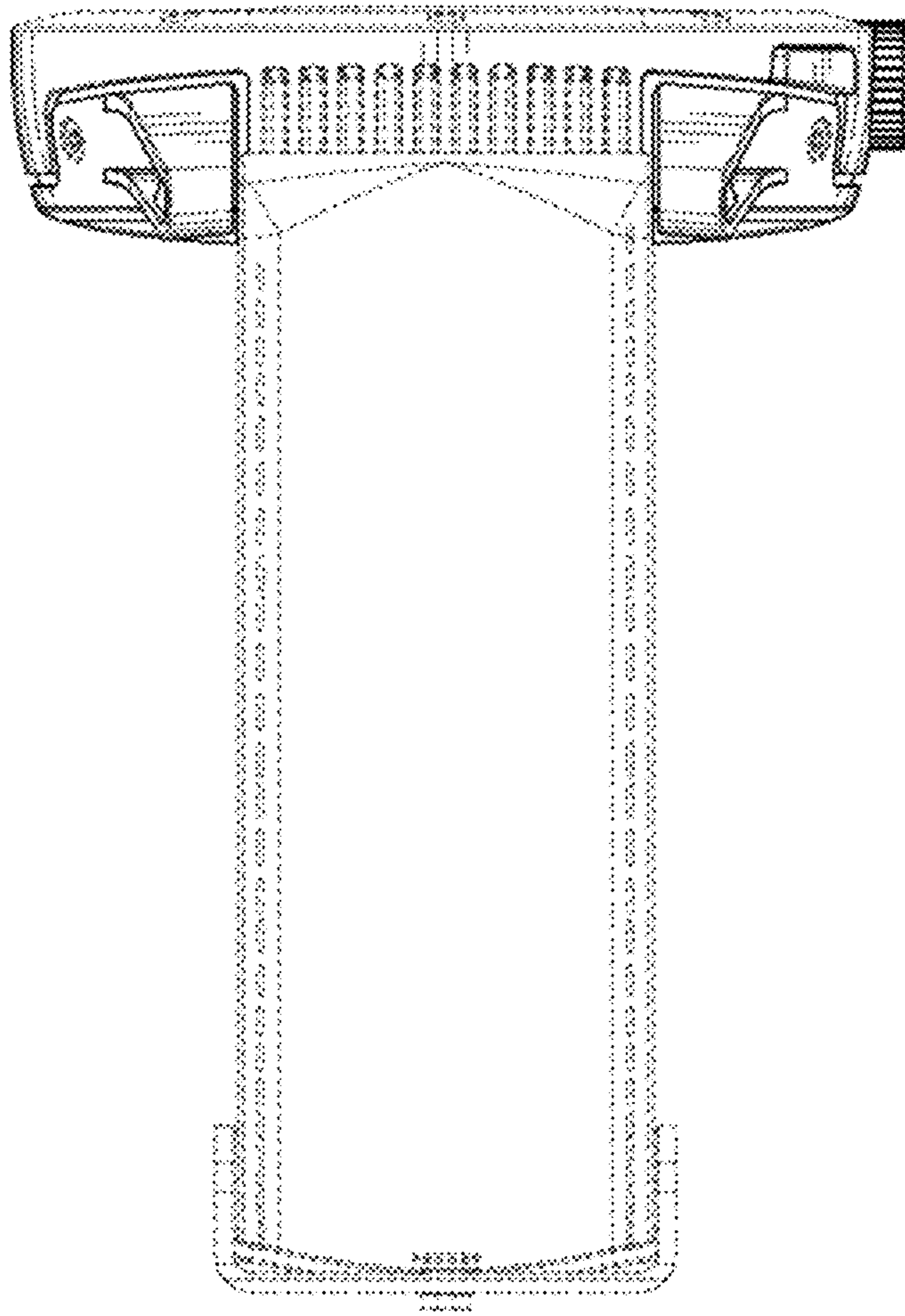


FIG. 7